

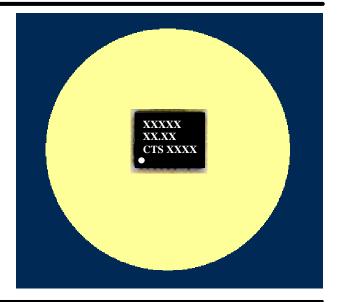


Features:

- SPI Digital frequency adjust
- Stable frequency over temperature
- Good SSBN Noise performance
- Customer Programmable Features
- Surface Mount Package

Description and Applications:

Surface mount 11x14 mm Temperature Compensated Crystal Oscillator (TCXO) for use in 3G, GSM, TDMA, CDMA, PDAs, Satellite handsets, 2-way radios, Pagers, Analog applications, and other portable electronics requiring a stable frequency source.

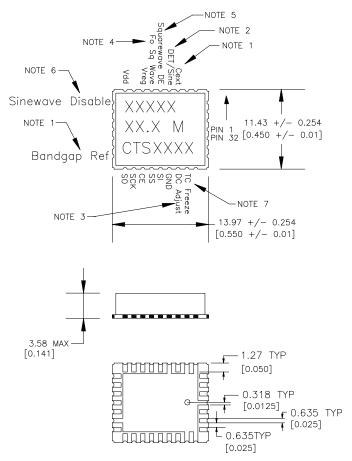


Electrical Specifications:

OSC1205B, D, F, H	Specification
Nominal Frequency	19.68 MHz
Supply Voltage (Vdd)	B and D: 3V ± 10% F and H: 5V ± 5%
Frequency Stability over Temperature	± 1.0 PPM (-30C to 85C)
RF output (DC Coupled)	B and F: 0.8 Vpp minimum, True Sinewave D and H: Vdd-0.5 minimum, Squarewave
Current Drain	B and F: <2 mA maximum (Sinewave) D and H: < 4 mA maximum (Squarewave)
Frequency Adjust Method	Digital SPI
Frequency Adjust Range	± 10 PPM minimum
SSBN at 10 kHz offset	-140 dBc/Hz maximum
Aging	± 1 PPM/Yr @25C

Model: OSC1205B, D, F, H Rev 021401

Mechanical Dimensions (mm):



DIMENSIONS: MM [INCHES]

NOTES

- FOR IMPROVED PHASE NOISE PERFORMANCE CONNECT A BYPASS CAPACITOR FROM THIS PIN TO GROUND (0.1 TO 1.0uf).
- 2. FACTORY PROGRAMMED FOR EITHER BUFFERED SINEWAVE OUTPUT OR PULLED TO GROUND. CAN BE GROUNDED IF SINE BUFFER IS NOT PROGRAMMED ON.
- 3. FACTORY PROGRAMMED TO PROVIDE DC VOLTAGE CONTROLLED FREQUENCY ADJUSTMENT OR NO CONNECTION. CAN BE GROUNDED IF DC V.C. IS DISABLED AT THE FACTORY.
- 4. FACTORY PROGRAMMED TO PROVIDE VDD-0.4V NOM. SQUAREWAVE OUTPUT OR TRISTATED. CAN BE CONNECTED TO GROUND IF SQUAREWAVE OUTPUT IS NOT PROGRAMMED ON. SQUAREWAVE OUTPUT MUST BE USED IF OUTPUT DIVIDER IS USED.
- 5. SQUAREWAVE OUTPUT CAN BE DISABLED BY PULLING DEVICE ENABLE PIN TO GROUND. (TO SAVE CURRENT "SLEEP" MODE).
- 6. SINEWAVE OUTPUT CAN BE DISABLED BY PULLING DISABLE PIN TO LOGIC 1. (TO SAVE CURRENT "SLEEP" MODE).
- 7. TC UPDATES CAN BE INHIBITED BY PULLING TC FREEZE PIN TO LOGIC 1.
- 8. NON-LABELED PINS MAY HAVE INTERNAL CONNECTIONS USED IN THE MANUFACTURING PROCESS. DO NOT MAKE CONNECTIONS TO NON-LABLED PINS